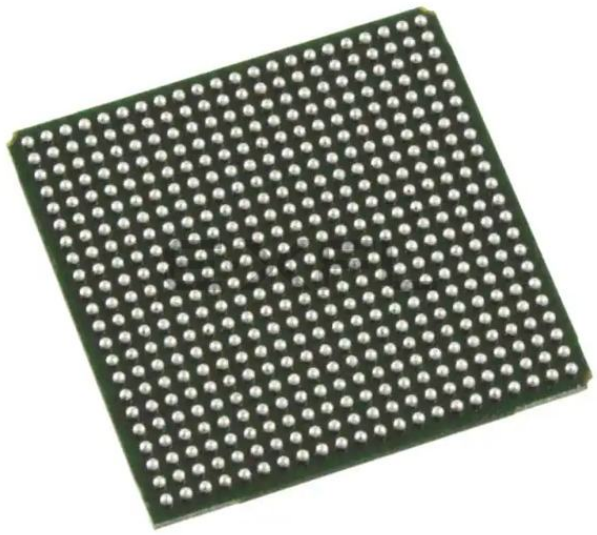
Lattice Semiconductor Corporation - LFE2-12E-7FN484C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

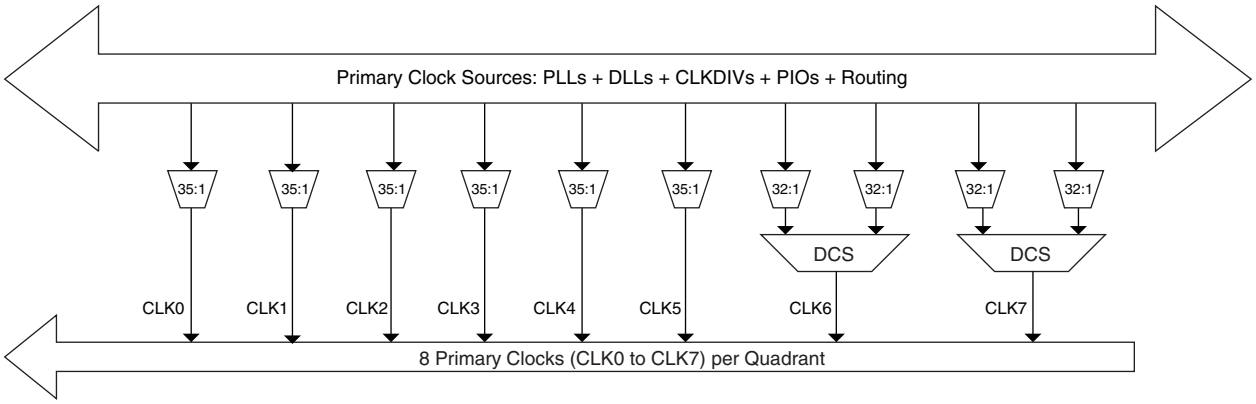
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	297
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12e-7fn484c

Primary Clock Routing

The clock routing structure in LatticeECP2/M devices consists of a network of eight primary clock lines (CLK0 through CLK7) per quadrant. The primary clocks of each quadrant are generated from muxes located in the center of the device. All the clock sources are connected to these muxes. Figure 2-13 shows the clock routing for one quadrant. Each quadrant mux is identical. If desired, any clock can be routed globally

Figure 2-13. Per Quadrant Primary Clock Selection

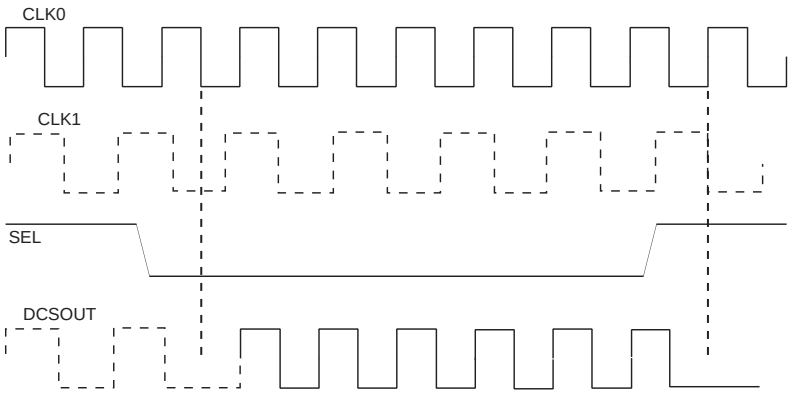


Dynamic Clock Select (DCS)

The DCS is a smart multiplexer function available in the primary clock routing. It switches between two independent input clock sources without any glitches or runt pulses. This is achieved regardless of when the select signal is toggled. There are two DCS blocks per quadrant; in total, there are eight DCS blocks per device. The inputs to the DCS block come from the center muxes. The output of the DCS is connected to primary clocks CLK6 and CLK7 (see Figure 2-13).

Figure 2-14 shows the timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-14. DCS Waveforms



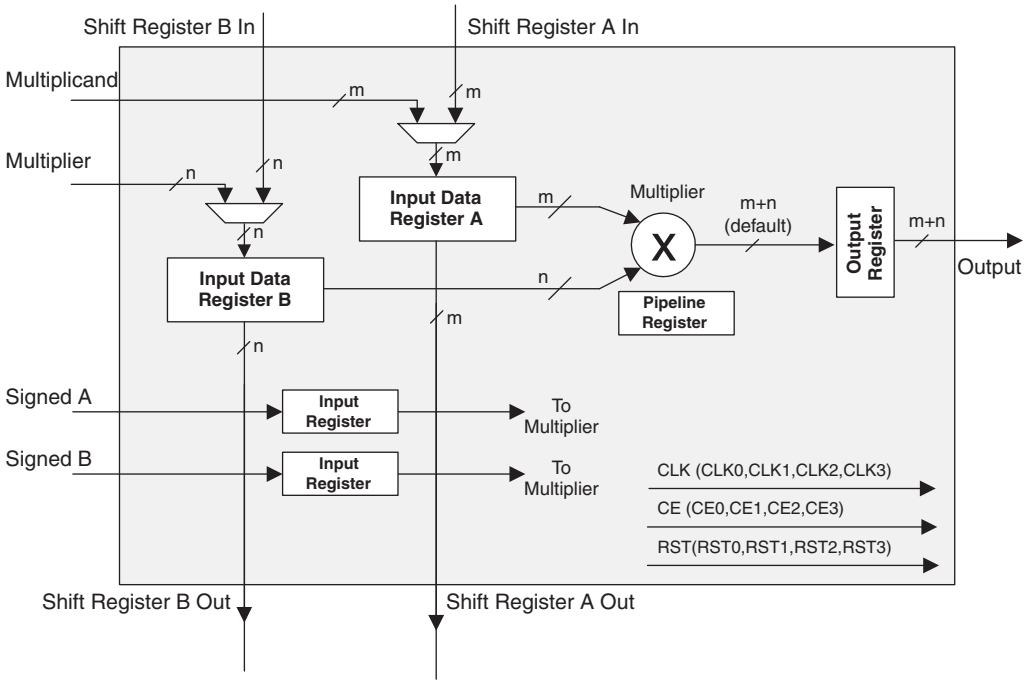
Secondary Clock/Control Routing

Secondary clocks in the LatticeECP2 devices are region-based resources. The benefit of region-based resources is the relatively low injection delay and skew within the region, as compared to primary clocks. EBR/DSP rows and a special vertical routing channel bound the secondary clock regions. This special vertical routing channel aligns with either the left edge of the center DSP block in the DSP row or the center of the DSP row. Figure 2-15 shows

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

Figure 2-23. MULT sysDSP Element



O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

Input Standard	V_{REF} (Nom.)	V_{CCIO}[1] (Nom.)
Single Ended Interfaces		
LVTTL	—	—
LVCMOS33	—	—
LVCMOS25	—	—
LVCMOS18	—	1.8
LVCMOS15	—	1.5
LVCMOS12	—	—
PCI 33	—	3.3
HSTL18 Class I, II	0.9	—
HSTL15 Class I	0.75	—
SSTL3 Class I, II	1.5	—
SSTL2 Class I, II	1.25	—
SSTL18 Class I, II	0.9	—
Differential Interfaces		
Differential SSTL18 Class I, II	—	—
Differential SSTL2 Class I, II	—	—
Differential SSTL3 Class I, II	—	—
Differential HSTL15 Class I	—	—
Differential HSTL18 Class I, II	—	—
LVDS, MLVDS, LVPECL, BLVDS, RSDS	—	—

1 When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

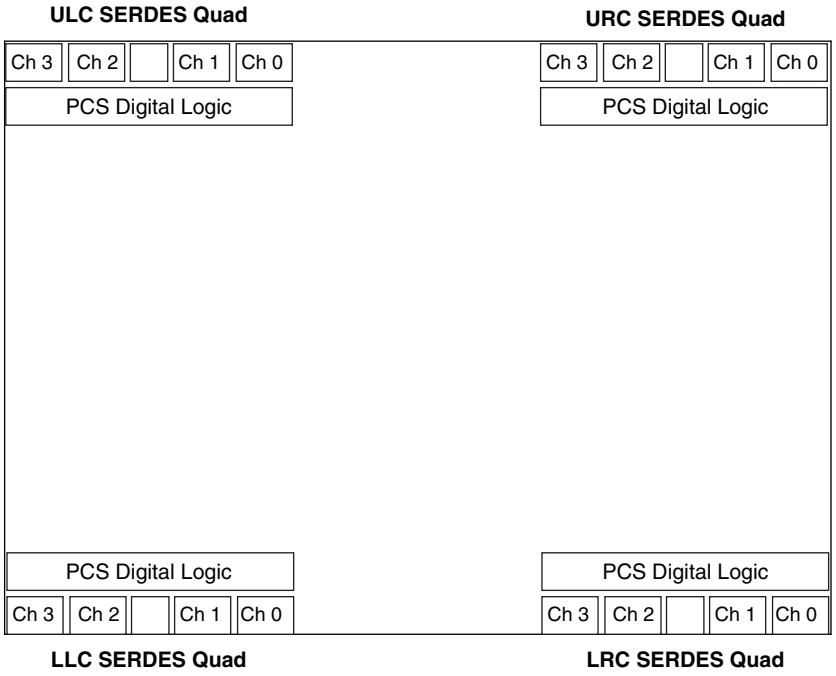


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

Device	URC Quad	ULC Quad	LRC Quad	LLC Quad
ECP2M20	Available	—	—	—
ECP2M35	Available	—	—	—
ECP2M50	Available	—	Available	—
ECP2M70	Available	Available	Available	Available
ECP2M100	Available	Available	Available	Available

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

Symbol	Parameter	Min.	Max.	Units
V_{CCP}[6]	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC}. If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX}. V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/µs during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC}, V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8}, the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of VCC or VCCAUX reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M “S” version devices only).
6. V_{CCRX},V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 Electrical Recommendations for Lattice SERDES.

Hot Socketing Specifications[1, 2, 3, 4]

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \le V_{IN} \le V_{IH}$ (MAX.)	—	—	+/-1000	µA
I_{HDIN}[5]	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC}, V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \le V_{CC} \le V_{CC}$ (MAX), $0 \le V_{CCIO} \le V_{CCIO}$ (MAX) or $0 \le V_{CCAUX} \le V_{CCAUX}$ (MAX).
3. I_{DK} is additive to I_{PU}, I_{PW} or I_{BH}.
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to LatticeECP2/M Product Family Qualification Summary for complete qualification data, including ESD performance.

LatticeECP2M Initialization Supply Current[1, 2, 3, 4]

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ.[5, 6, 7]	Units
I_{CC}	Core Power Supply Current	ECP2M20	41	mA
		ECP2M35	107	mA
		ECP2M50	169	mA
		ECP2M70	254	mA
		ECP2M100	378	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	30	mA
		ECP2M35	30	mA
		ECP2M50	30	mA
		ECP2M70	30	mA
		ECP2M100	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. T_J = 25ºC, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}[1]	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}[2]	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}[3]	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.
2. CLKOS minimum frequency is obtained with divide by 4.
3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M6	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*
M3	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T
GNDIO	GNDIO6	-			-	-		
M4	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C
-	-	-			VCCIO6	6		
N1	NC	-			PL24A	6	LDQ25	T
M2	NC	-			PL23A	6	LDQ25	T (LVDS)*
N2	NC	-			PL24B	6	LDQ25	C
M1	NC	-			PL23B	6	LDQ25	C (LVDS)*
-	-	-			GNDIO	-		
N3	NC	-			PL25A	6	LDQS25	T (LVDS)*
N5	NC	-			PL26A	6	LDQ25	T
N4	NC	-			PL25B	6	LDQ25	C (LVDS)*
-	-	-			VCCIO6	6		
P5	NC	-			PL26B	6	LDQ25	C
P1	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*
P2	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*
P4	PL18A	6	LLM0_GDLLT_FB_A	T	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T
-	-	-			GNDIO	-		
R4	PL18B	6	LLM0_GDLLC_FB_A	C	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C
P6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
R1	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*
GNDIO	GNDIO6	-			-	-		
R3	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T
R2	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A/LDQ34	C (LVDS)*
T4	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C
T5	PL23A	6		T	PL33A	6	LDQ34	T
VCCIO	VCCIO6	6			VCCIO6	6		
T1	PL22A	6		T (LVDS)*	PL32A	6	LDQ34	T (LVDS)*
T3	PL23B	6		C	PL33B	6	LDQ34	C
T2	PL22B	6		C (LVDS)*	PL32B	6	LDQ34	C (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
-	-	-			VCCIO6	6		
V1	PL25A	6	LDQ28	T	PL39A	6	LDQ42	T
-	-	-			GNDIO	-		
V2	PL25B	6	LDQ28	C	PL39B	6	LDQ42	C
U1	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*
U3	PL27A	6	LDQ28	T	PL41A	6	LDQ42	T
VCCIO	VCCIO6	6			VCCIO6	6		
U2	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*
U4	PL27B	6	LDQ28	C	PL41B	6	LDQ42	C
R6	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*
R7	PL29A	6	LDQ28	T	PL43A	6	LDQ42	T
GNDIO	GNDIO6	-			GNDIO	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	PL24B	7	LDQ24	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*
L1	PL25A	7	LUM0_SPLLT_IN_A/LDQ24	T	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7			VCCIO7	7		
M2	PL25B	7	LUM0_SPLLC_IN_A/LDQ24	C	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
M1	PL26A	7	LUM0_SPLLT_FB_A/LDQ24	T	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N2	PL26B	7	LUM0_SPLLC_FB_A/LDQ24	C	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-			GNDIO7	-		
M8	VCCPLL	7			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL37A	7	LDQ41		PL50A	7	LDQ54	
L8	PL38A	7	LDQ41	T	PL51A	7	LDQ54	T
K8	PL38B	7	LDQ41	C	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL39A	7	LDQ41	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
K5	PL39B	7	LDQ41	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
L7	PL40A	7	LDQ41	T	PL53A	7	LDQ54	T
L5	PL40B	7	LDQ41	C	PL53B	7	LDQ54	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL41A	7	LDQS41	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
P2	PL41B	7	LDQ41	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
M6	PL42A	7	LDQ41	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL42B	7	LDQ41	C	PL55B	7	LDQ54	C
R1	PL43A	7	LDQ41	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
R2	PL43B	7	LDQ41	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
M7	PL44A	7	PCLKT7_0/LDQ41	T	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL44B	7	PCLKC7_0/LDQ41	C	PL57B	7	PCLKC7_0/LDQ54	C
M4	PL46A	6	PCLKT6_0/LDQ50	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
M5	PL46B	6	PCLKC6_0/LDQ50	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
N7	PL47A	6	VREF2_6/LDQ50	T	PL60A	6	VREF2_6/LDQ63	T
P9	PL47B	6	VREF1_6/LDQ50	C	PL60B	6	VREF1_6/LDQ63	C
N3	PL48A	6	LDQ50	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL48B	6	LDQ50	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
N5	PL49A	6	LDQ50	T	PL62A	6	LDQ63	T
P7	PL49B	6	LDQ50	C	PL62B	6	LDQ63	C
T1	PL50A	6	LDQS50	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	PL50B	6	LDQ50	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
P8	PL51A	6	LDQ50	T	PL64A	6	LDQ63	T
P6	PL51B	6	LDQ50	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	PL52A	6	LDQ50	T (LVDS)*	PL65A	6	LDQ63	T (LVDS)*
P4	PL52B	6	LDQ50	C (LVDS)*	PL65B	6	LDQ63	C (LVDS)*

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO5	-			GNDIO5	-		
W10	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
Y10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
W11	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AC8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
AD8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
AB8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
AB10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AE6	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AF6	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AA11	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AC9	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
AB9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
AD9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
Y11	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AB11	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
AE7	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T
AF7	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AC10	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AD10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
AA12	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
W12	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
AB12	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
Y12	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
AD12	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AC12	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
AC13	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
GND	GNDIO5	-			GNDIO5	-		
AA13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AD13	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AC14	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AE8	PB35A	5	BDQ33	T	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
AF8	PB35B	5	BDQ33	C	PB44B	5	BDQ42	C
AB15	PB36A	5	BDQ33	T	PB45A	5	BDQ42	T
Y13	PB36B	5	BDQ33	C	PB45B	5	BDQ42	C
AE9	PB37A	5	BDQ33	T	PB46A	5	BDQ42	T
GND	GNDIO5	-			GNDIO5	-		
AF9	PB37B	5	BDQ33	C	PB46B	5	BDQ42	C
W13	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT75B	1		C	PT93B	1		C
D20	PT75A	1		T	PT93A	1		T
A22	PT74B	1		C	PT92B	1		C
A21	PT74A	1		T	PT92A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	PT71B	1		C	PT85B	1		C
C19	PT71A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B21	PT70B	1		C	PT79B	1		C
B20	PT70A	1		T	PT79A	1		T
D19	PT69B	1		C	PT78B	1		C
B19	PT69A	1		T	PT78A	1		T
GND	GNDIO1	-			GNDIO1	-		
G17	PT68B	1		C	PT77B	1		C
E18	PT68A	1		T	PT77A	1		T
G19	PT67B	1		C	PT76B	1		C
F17	PT67A	1		T	PT76A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A20	PT66B	1		C	PT75B	1		C
A19	PT66A	1		T	PT75A	1		T
E17	PT65B	1		C	PT74B	1		C
D18	PT65A	1		T	PT74A	1		T
B18	PT64B	1		C	PT73B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT64A	1		T	PT73A	1		T
E16	PT63B	1		C	PT72B	1		C
G16	PT63A	1		T	PT72A	1		T
F16	PT62B	1		C	PT71B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT62A	1		T	PT71A	1		T
A17	PT61B	1		C	PT70B	1		C
B17	PT61A	1		T	PT70A	1		T
C18	PT60B	1		C	PT69B	1		C
B16	PT60A	1		T	PT69A	1		T
C17	PT59B	1		C	PT68B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT59A	1		T	PT68A	1		T
E15	PT58B	1		C	PT67B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
G15	PT58A	1		T	PT67A	1		T
A16	PT57B	1		C	PT66B	1		C
B15	PT57A	1		T	PT66A	1		T
D15	PT56B	1		C	PT65B	1		C
F15	PT56A	1		T	PT65A	1		T
A14	PT55B	1		C	PT64B	1		C
B14	PT55A	1		T	PT64A	1		T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AJ6	PB16A	5	BDQ15	T
AK6	PB16B	5	BDQ15	C
VCCIO	VCCIO5	5		
GND	GNDIO5	-		
AD10	PB29A	5	BDQ33	T
AF10	PB29B	5	BDQ33	C
AC11	PB30A	5	BDQ33	T
AD11	PB30B	5	BDQ33	C
AG9	PB31A	5	BDQ33	T
AH9	PB31B	5	BDQ33	C
VCCIO	VCCIO5	99		
AE11	PB32A	5	BDQ33	T
AG10	PB32B	5	BDQ33	C
GND	GNDIO5	-		
AJ9	PB33A	5	BDQS33	T
AK9	PB33B	5	BDQ33	C
AF11	PB34A	5	BDQ33	T
AH10	PB34B	5	BDQ33	C
AC12	PB35A	5	BDQ33	T
AE12	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5		
AD12	PB36A	5	BDQ33	T
AF12	PB36B	5	BDQ33	C
AJ10	PB37A	5	BDQ33	T
AK10	PB37B	5	BDQ33	C
GND	GNDIO5	-		
AG11	PB38A	5	BDQ42	T
AH11	PB38B	5	BDQ42	C
AE13	PB39A	5	BDQ42	T
AC13	PB39B	5	BDQ42	C
AF13	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5		
AD13	PB40B	5	BDQ42	C
AJ11	PB41A	5	BDQ42	T
AK11	PB41B	5	BDQ42	C
AD14	PB42A	5	BDQS42	T
GND	GNDIO5	-		
AC14	PB42B	5	BDQ42	C
AG12	PB43A	5	BDQ42	T
AE14	PB43B	5	BDQ42	C
AJ12	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5		
AK12	PB44B	5	BDQ42	C

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO6	-			GNDIO6	-		
L1	PL42A	6	LLM0_GPLLT_IN_A	T (LVDS)*	PL57A	6	LLM0_GPLLT_IN_A**/LDQS57***	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
L2	PL42B	6	LLM0_GPLLC_IN_A	C (LVDS)*	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C(LVDS)*
L3	PL43A	6	LLM0_GPLLT_FB_A	T	PL58A	6	LLM0_GPLLT_FB_A/LDQ57	T
L4	PL43B	6	LLM0_GPLLC_FB_A	C	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C
VCCIO	VCCIO6	6			VCCIO6	6		
M1	PL44A	6	LLM0_GDLLT_IN_A	T (LVDS)*	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*
N1	PL44B	6	LLM0_GDLLC_IN_A	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C(LVDS)*
N2	PL45A	6	LLM0_GDLLT_FB_A	T	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T
N3	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C
GNDIO	GNDIO6	-			GNDIO6	-		
M4	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
VCCIO	VCCIO6	6			VCCIO6	6		
GNDIO	GNDIO6	-			GNDIO6	-		
K6	TCK	-			TCK	-		
L5	TDI	-			TDI	-		
N4	TMS	-			TMS	-		
N6	TDO	-			TDO	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T
N5	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C
L6	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
M6	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
P3	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
P4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
P2	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
P1	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
R1	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
GNDIO	GNDIO5	-			GNDIO5	-		
R2	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
R3	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
T2	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
R4	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
T4	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
GNDIO	GNDIO5	-			GNDIO5	-		
T5	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
T6	PB16A	5	VREF2_5/BDQ15	T	PB34A	5	VREF2_5/BDQ33	T
R6	PB16B	5	VREF1_5/BDQ15	C	PB34B	5	VREF1_5/BDQ33	C
P6	PB17A	5	PCLKT5_0/BDQ15	T	PB35A	5	PCLKT5_0/BDQ33	T
P7	PB17B	5	PCLKC5_0/BDQ15	C	PB35B	5	PCLKC5_0/BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F15	NC	-			NC	-		
F14	NC	-			NC	-		
F13	NC	-			NC	-		
G12	NC	-			NC	-		
G13	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated sysCONFIG pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).
****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A12	PT35B	0		C	PT44B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
A11	PT35A	0		T	PT44A	0		T
D12	PT34B	0		C	PT43B	0		C
H16	PT34A	0		T	PT43A	0		T
H18	PT33B	0		C	PT42B	0		C
H15	PT33A	0		T	PT42A	0		T
A10	PT32B	0		C	PT41B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
B10	PT32A	0		T	PT41A	0		T
D11	PT31B	0		C	PT40B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
G14	PT31A	0		T	PT40A	0		T
E11	PT30B	0		C	PT39B	0		C
F13	PT30A	0		T	PT39A	0		T
D10	PT29B	0		C	PT38B	0		C
H14	PT29A	0		T	PT38A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
VCCIO	VCCIO0	0			VCCIO0	0		
A9	PT24B	0		C	PT24B	0		C
C10	PT23B	0		C	PT23B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
E8	PT23A	0		T	PT23A	0		T
B9	PT22B	0		C	PT22B	0		C
A8	PT22A	0		T	PT22A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
F12	PT21B	0		C	PT21B	0		C
E10	PT21A	0		T	PT21A	0		T
G13	PT20B	0		C	PT20B	0		C
C9	PT20A	0		T	PT20A	0		T
B8	PT19B	0		C	PT19B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
A7	PT19A	0		T	PT19A	0		T
D9	PT18B	0		C	PT18B	0		C
H13	PT18A	0		T	PT18A	0		T
D6	PT17B	0		C	PT17B	0		C
C7	PT17A	0		T	PT17A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
C8	PT16B	0		C	PT16B	0		C
G12	PT16A	0		T	PT16A	0		T
D8	PT15B	0		C	PT15B	0		C
H12	PT15A	0		T	PT15A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
A6	PT14B	0		C	PT14B	0		C
A5	PT14A	0		T	PT14A	0		T
A4	PT13B	0		C	PT13B	0		C
A3	PT13A	0		T	PT13A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C6	PT12B	0		C	PT12B	0		C
F10	PT12A	0		T	PT12A	0		T
D7	PT11B	0		C	PT11B	0		C
H11	PT11A	0		T	PT11A	0		T
D5	PT10B	0		C	PT10B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
E6	PT10A	0		T	PT10A	0		T
G10	PT9B	0		C	PT9B	0		C
F9	PT9A	0		T	PT9A	0		T
H10	PT8B	0		C	PT8B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E7	PT8A	0		T	PT8A	0		T
B3	PT7B	0		C	PT7B	0		C
C5	PT7A	0		T	PT7A	0		T
B2	PT6B	0		C	PT6B	0		C
C4	PT6A	0		T	PT6A	0		T
G9	PT5B	0		C	PT5B	0		C
GNDIO	GNDIO0	-			GNDIO0	-		
F7	PT5A	0		T	PT5A	0		T
C3	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
D4	PT4A	0		T	PT4A	0		T
J10	PT3B	0		C	PT3B	0		C
F8	PT3A	0		T	PT3A	0		T
G8	PT2B	0		C	PT2B	0		C
G7	PT2A	0		T	PT2A	0		T
L12	VCC	-			VCC	-		
L13	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L15	VCC	-			VCC	-		
M11	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M15	VCC	-			VCC	-		
M16	VCC	-			VCC	-		
N11	VCC	-			VCC	-		
N16	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
R11	VCC	-			VCC	-		
R12	VCC	-			VCC	-		
R15	VCC	-			VCC	-		
R16	VCC	-			VCC	-		
T12	VCC	-			VCC	-		
T13	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T15	VCC	-			VCC	-		
B12	VCCIO0	0			VCCIO0	0		
B7	VCCIO0	0			VCCIO0	0		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5F484C	331	1.2V	-5	fpBGA	484	Com	35
LFE2-35SE-6F484C	331	1.2V	-6	fpBGA	484	Com	35
LFE2-35SE-7F484C	331	1.2V	-7	fpBGA	484	Com	35
LFE2-35SE-5F672C	450	1.2V	-5	fpBGA	672	Com	35
LFE2-35SE-6F672C	450	1.2V	-6	fpBGA	672	Com	35
LFE2-35SE-7F672C	450	1.2V	-7	fpBGA	672	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5F484C	339	1.2V	-5	fpBGA	484	Com	50
LFE2-50SE-6F484C	339	1.2V	-6	fpBGA	484	Com	50
LFE2-50SE-7F484C	339	1.2V	-7	fpBGA	484	Com	50
LFE2-50SE-5F672C	500	1.2V	-5	fpBGA	672	Com	50
LFE2-50SE-6F672C	500	1.2V	-6	fpBGA	672	Com	50
LFE2-50SE-7F672C	500	1.2V	-7	fpBGA	672	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5F672C	500	1.2V	-5	fpBGA	672	Com	70
LFE2-70SE-6F672C	500	1.2V	-6	fpBGA	672	Com	70
LFE2-70SE-7F672C	500	1.2V	-7	fpBGA	672	Com	70
LFE2-70SE-5F900C	583	1.2V	-5	fpBGA	900	Com	70
LFE2-70SE-6F900C	583	1.2V	-6	fpBGA	900	Com	70
LFE2-70SE-7F900C	583	1.2V	-7	fpBGA	900	Com	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5T144I	90	1.2V	-5	TQFP	144	Ind	6
LFE2-6SE-6T144I	90	1.2V	-6	TQFP	144	Ind	6
LFE2-6SE-5F256I	190	1.2V	-5	fpBGA	256	Ind	6
LFE2-6SE-6F256I	190	1.2V	-6	fpBGA	256	Ind	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5T144I	93	1.2V	-5	TQFP	144	Ind	12
LFE2-12SE-6T144I	93	1.2V	-6	TQFP	144	Ind	12
LFE2-12SE-5Q208I	131	1.2V	-5	PQFP	208	Ind	12
LFE2-12SE-6Q208I	131	1.2V	-6	PQFP	208	Ind	12
LFE2-12SE-5F256I	193	1.2V	-5	fpBGA	256	Ind	12
LFE2-12SE-6F256I	193	1.2V	-6	fpBGA	256	Ind	12
LFE2-12SE-5F484I	297	1.2V	-5	fpBGA	484	Ind	12
LFE2-12SE-6F484I	297	1.2V	-6	fpBGA	484	Ind	12

LatticeECP2M Standard Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
			Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
April 2008	03.1	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
June 2008	03.2	Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
			Clarification of the operation of the secondary clock regions.
		DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
August 2008	03.3	Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPIm Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t_{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.